Surface Mount Schottky Barrier Rectifier

Parameter	Value	Unit
V_{RRM}	20~200	V
$I_{F(AV)}$	2.0	A

SOD-123FL

Features

- Metal silicon junction, majority carrier conduction
- For surface mounted applications
- Low power loss, high efficiency
- High forward surge current capability

Applications

- For use in low-voltage, high-frequency inverters, free-wheeling applications, DC/DC converters, and polarity protection circuits.

Absolute Maximum Ratings and Characteristics (at TJ = 25℃ unless otherwise specified)

Parameter	Symbol	SS22L	SS24L	SS26L	SS28L	SS210L	SS212L	SS215L	SS220L	Units
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	20	40	60	80	100	120	150	200	V
Maximum RMS voltage	V_{RMS}	14	28	42	56	70	84	105	140	V
Maximum DC Blocking Voltage	V_{DC}	20	40	60	80	100	120	150	200	V
Maximum Average Forward Rectified Current	$I_{F(AV)}$	2.0								A
Peak Forward Surge Current ,8.3ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method)	I_{FSM}	50								A
Max Instantaneous Forward Voltage at 2 A	V_F	0.55		0.70		0.85		0.95		V
Maximum DC Reverse Current Ta = 25℃ at Rated DC Reverse Voltage Ta = 100℃	I_R	0.5 5			0.3 3					mA
Typical Junction Capacitance（1）	C_j	220		80						pF
Typical Thermal Resistance（2）	$R_{\theta JA}$	85								℃/W
Operating Junction Temperature Range	T_j	-55 ~ +125		-55 ~ +150						℃
Storage Temperature Range	T_{stg}	-55 ~ +150								℃

Notes：

（1）Measured at 1 MHz and applied reverse voltage of 4 V D.C

（2）P.C.B. mounted with 2.0" X 2.0" (5 X 5 cm) copper pad areas.

Typical characteristics

Fig.1 Forward Current Derating Curve

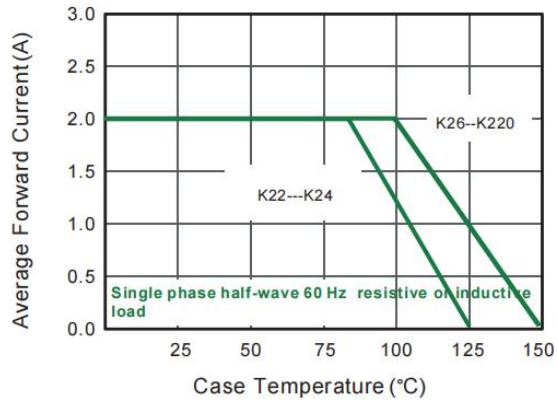


Fig.2 Typical Reverse Characteristics

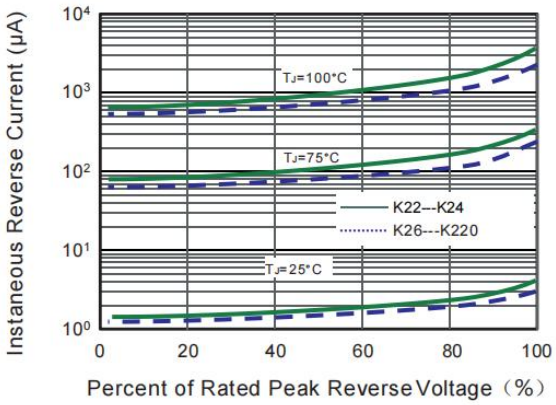


Fig.3 Typical Forward Characteristic

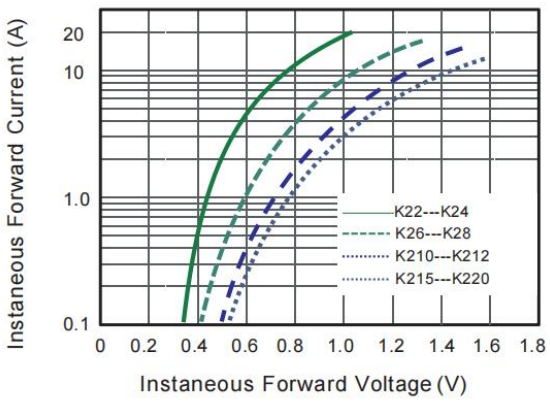


Fig.4 Typical Junction Capacitance

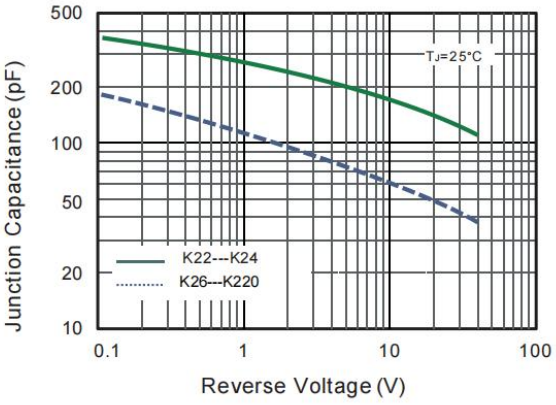


Fig.5 Maximum Non-Repetitive Peak Forward Surage Current

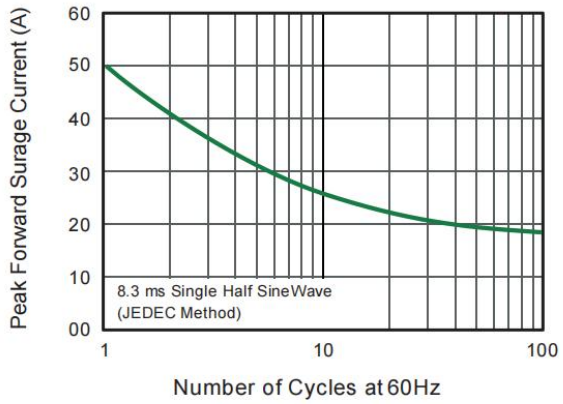
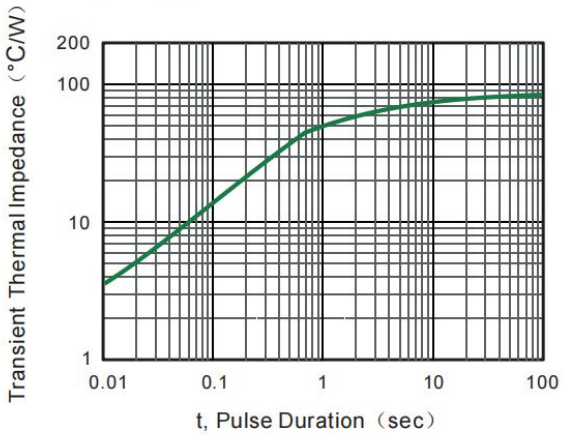


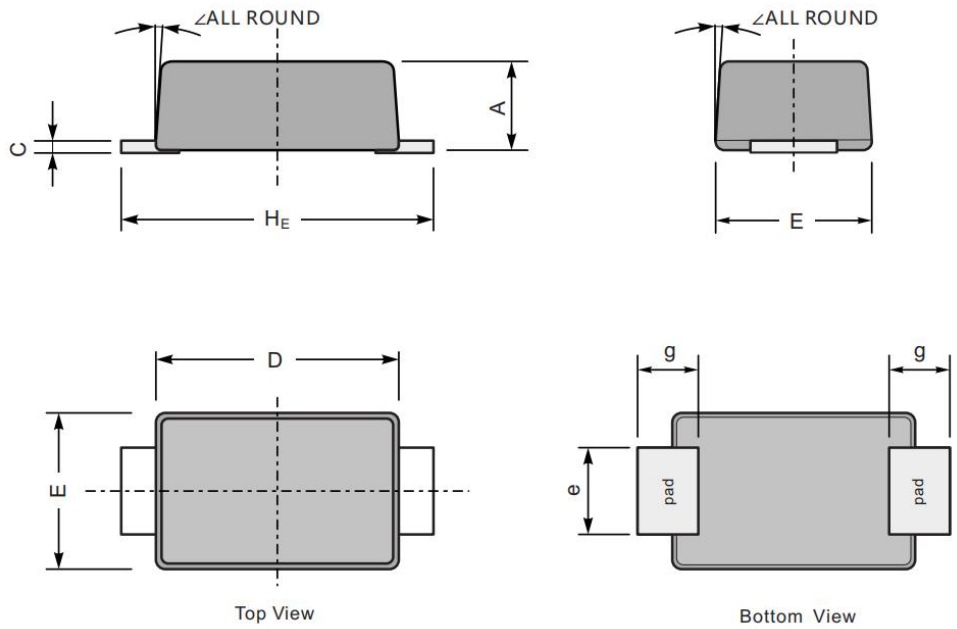
Fig.6- Typical Transient Thermal Impedance



Package outlines

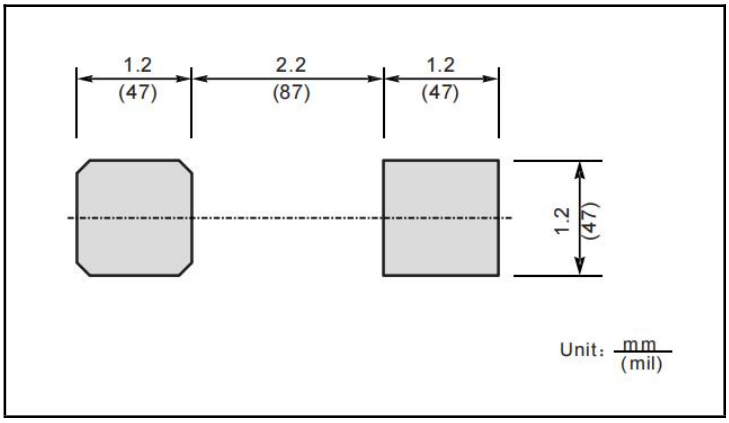
Plastic surface mounted package; 2 leads

SOD-123FL



UNIT		A	C	D	E	e	g	B	∠
mm	max	1.15	0.20	2.8	2.0	1.2	0.9	3.8	5°
	min	0.95	0.12	2.5	1.7	0.9	0.7	3.5	
mil	max	45	7.9	110	78.7	47	35	150	
	min	37	4.7	98	67	35	28	138	

The recommended mounting pad size



Marking

Type number	Marking code
SS22L	K22
SS24L	K24
SS26L	K26
SS28L	K28
SS210L	K210
SS212L	K212
SS215L	K215
SS220L	K220

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